



Annual Event 2024



Surface technology meets industrial reversible bonding

To facilitate the disassembly of components and multilayer systems, required for circular economy, controlled debonding is of high importance. Reversible bonding can be achieved by combining surface treatment technologies with functional additives interacting specifically with one or more trigger systems. However, there are several practical challenges in implementing these techniques, which we will discuss with leading experts.

Due to their advantageous properties, plastics are bonded in many material composites. With regard to recyclability, solutions for de-bonding are therefore also a key issue for the plastics industry when it comes to the reparability or recycling of intelligent systems or recycling of multilayer polymers.

Thursday, 24 October 2024, 10.30h - 16.45h, HTA-Fribourg, Boulevard de Pérolles 80, CH-1700 Fribourg

Morning program: Roundtables with showcases

Afternoon program: Surface technology meets industrial reversible bonding

Registration

info@innovativesurfaces.ch or www.innovativesurfaces.ch.

Fee for participation:

Members NTN Innovative Surfaces CHF 60.-, non-members CHF 90.- (excl. VAT).

Cancellation policy:

Administrative fee CHF 45.-, substitutes accepted.

Foyer Exhibition

Tables and power supply available. Fee CHF 360.00 (excl. VAT).

info@innovativesurfaces.ch

Association NTN Innovative Surfaces
Lagerstrasse 14 I Chemin des Verdiers 4
CH-8600 Dübendorf I CH-1700 Fribourg



10.30	Roundtables / Showcases
12.00	Lunch / Tabletop Foyer Exhibition
13.00	Plenum Talks
15.00	Coffee break / Tabletop Foyer Exhibition
15.30	Plenum Talks
16.45	Apéro / Tabletop Foyer Exhibition

A day full of show cases & expertise

Foyer Exhibition

Tables available: book now
info@innovativesurfaces.ch



Morning program - Roundtables

10.30h - 12.00h Showcases & best practise



Sol-gel processes for the elaboration of protective and responsive coatings, Xavier Bulliard, CSEM SA



Reliable plasma treatment for the production of sensitive medical electronics, Klaus Kresser, Plasmatreat Schweiz AG



AAA COAT-Beschichtung: Eine Alternative zu Eloxa!?

Roman Fuchs, FME GmbH



Shape Memory Polymer for devices customizable at body temperature

Ana Marques, Adolphe Merkle Institute, University of Fribourg



Covalent adaptable networks for bonding-debonding & repair applications, Sabyasachi Gaan, Empa



Reactive inkjet printing of Ni nanoparticles for CO2 electrochemical conversion



Mathieu Soutrenon, HES-SO Valais-Wallis, iPrint Institute, HEFR



Oberflächenbearbeitung durch Gleitschleifen/Strahlen vor einer Beschichtung, Daniel Müller, Rösler Schweiz AG



AQibond™ – Low Temperature Adhesion Promoter for High Precision Plastics, Sina Göhl, Susos AG



Environmentally friendly coatings for skies

Giulia Morgese, ZHAW Zurich University of Applied Sciences

12.00 Buffet lunch



In cooperation with:
 Swiss Plastics Cluster

Afternoon program - Plenum talks

13.00h - 16.45h Auditoire Edouard Gremaud

Surface technology meets industrial reversible bonding

13.00 Welcome and introduction

Andreas Hafner, Jörg Güttinger, NTN Innovative Surfaces
 Lorenz Herrmann, Empa



Life-cycle assessment impact of reversible bonding

Marc Majo, Empa

Debonding primer for the circularity of multimatials

Robin Szymanski, Applus+ Rescoll

APM Unocol, temperature controllable adhesive / protective coatings, Mike Achtzehn, APM Technica AG

Surface treatment for debonding on demand

Katrin Hoffmann, OST – Ostschweizer Fachhochschule

15.00 Coffee Break

15.30 Waterbased Epolad adhesives - Recycling Loop for PET-Based Multilayer, Ines Pietsch, BASF SE

Debonding on demand for coatings

Oliver Strube, University of Innsbruck

Kalttrenn-Technologie zur Trennung von Klebeverbindungen

Jens W. Kipp, mycon GmbH

16.45 Networking Apéro

Marc
Majo



Empa
Materials Science and Technology

Ines
Pietsch



BASF
We create chemistry

Mike
Achtzehn



APM
Technica
Adhesive & Surface Technology

Robin
Szymanski



Applus+
RESCOLL

Oliver
Strube



universität
Innsbruck

Jens w.
Kipp



mycon
GmbH

Katrin
Hoffmann



OST
Ostschweizer
Fachhochschule